

App. No. 10/708,301
Amendment dated October 18, 2005
Reply to Office action of April 19, 2005

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the present application.

Listing of Claims:

Claim 1 (currently amended): A holder for semiconductor as well as liquid-crystal manufacturing devices, the holder comprising:

a ceramic susceptor of a ceramic whose thermal conductivity is 100 W/mK or more, said susceptor having a retaining side for retaining an object to be processed;

a resistive heating element incorporated in said susceptor, said resistive heating element patterned in a circuit having a pattern spacing of 0.1 mm or more; and

a heat-reflecting metal plate having a thermal conductivity of 100 W/mK or more, said metal plate arranged on said susceptor opposite said retaining side, for promoting diffusion of heat from said resistive heating element toward said retaining side.

Claim 2 (original): A holder as set forth in claim 1, wherein said metal plate and said ceramic susceptor are fastened by bonding, screws, snug-fitting, or vacuum adhesion.

Claim 3 (original): A holder as set forth in claim 1, wherein the resistive heating element is present beyond the middle in the thickness direction of said susceptor, toward the side opposite said retaining side.

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Claim 4 (original): A holder as set forth in claim 1, wherein the ceramic of said ceramic susceptor is any one selected from Al_2O_3 , SiO_2 , B_4C and BN .

Claim 5 (cancelled)

Claim 6 (currently amended): A holder as set forth in claim ~~[[5]]~~ 1, wherein the ceramic of said ceramic susceptor is any one selected from AlN , SiC and Si_3N_4 .

Claim 7 (cancelled)

Claim 8 (currently amended): A holder as set forth in claim ~~[[7]]~~ 1, wherein said metal is any one selected from Al-SiC , Cu-W and Cu-Mo .

Claim 9 (original): A holder as set forth in claim 1, wherein the thickness of said metal plate is thicker than the thickness of said ceramic susceptor.

Claim 10 (original): A holder as set forth in claim 1, wherein the diameter of said ceramic susceptor is 200 mm or more.

Claim 11 (original): A holder as set forth in claim 1, wherein the porosity of the ceramic of said ceramic susceptor is 0.03% or less.

Claim 12 (previously presented): A holder as set forth in claim 1, wherein said retaining side has a warpage of 500 μm or less.

Claim 13 (original): A semiconductor manufacturing device in which the holder of claim 1 is installed.

Claim 14 (original): A liquid-crystal manufacturing device in which the holder of claim 1 is installed.